



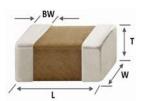
Specification of Automotive MLCC (Reference sheet)

● Supplier : Samsung electro-mechanics ● Samsung P/N : CL05C2R7CB51PNC

● AEC-Q200 Qualified

A. Dimension

Dimension



Size	0402 inch
L	1.00±0.05 mm
W	0.50±0.05 mm
Т	0.50±0.05 mm
BW	0.25±0.10 mm

B. Samsung Part Number

<u>CL</u>	<u>05</u>	<u>C</u>	<u>2R7</u>	<u>C</u>	<u>B</u>	<u>5</u>	<u>1</u>	<u>P</u>	<u>N</u>	<u>C</u>
①	2	3	4	(5)	6	⑦	8	9	10	11

① Series	Samsung Multi-layer Ceramic Capacitor		
② Size	0402 (inch code)	L: 1.00±0.05 mm	W: 0.50±0.05 mm
3 Dielectric	COG	8 Inner electrode	Ni
4 Capacitance	2.7 pF	Termination	Cu
⑤ Capacitance	± 0.25pF	Plating	Sn 100% (Pb Free)
tolerance		9 Product	Automotive
Rated Voltage	50 V	Special code	Normal
7 Thickness	0.50±0.05 mm	1 Packaging	Cardboard Type, 7" Reel

C. Reliability Test and Judgement condition

	Performance	Test condition
High Temperature	Appearance : No abnormal exterior appearance	Unpowered, 1,000hrs @ Max. temperature
Exposure	Capacitance Change: Within ±2.5% or ±0.25pF	Measurement at 24±2hrs after test conclusion
	whichever is larger	
	Q: 454 min.	
	IR : More than 10,000 № or 500 №× µF	
	Whichever is smaller	
Temperature Cycling	Appearance : No abnormal exterior appearance	1,000Cycles
	Capacitance Change: Within ±2.5% or ±0.25pF	Measurement at 24±2hrs after test conclusion
	whichever is larger	
	Q: 454 min.	1 cycle condition : -55+0/-3°C(30±3min) → Room Temp. (1min)
	IR : More than 10,000 № or 500 №×μF	\rightarrow 125+3/-0 $^{\circ}$ C(30±3min) \rightarrow Room Temp. (1min)
	Whichever is smaller	
Destructive Physical	No Defects or abnormalities	Per EIA 469
Analysis		
Humidity Bias	Appearance : No abnormal exterior appearance	1,000hrs 85 ℃/85%RH, Rated Voltage and 1.3~1.5V,
	Capacitance Change: Within ±2.5% or ±0.25pF	Add 100kohm resistor
	whichever is larger	
	Q: 108.991 min.	The charge/discharge current is less than 50mA.
	IR : More than 500 MΩ or 25 MΩ×μF	
	Whichever is smaller	
High Temperature	Appearance : No abnormal exterior appearance	1,000hrs @ 125 ℃, 200% Rated Voltage,
Operating Life	Capacitance Change: Within ±3% or ±0.3pF	Measurement at 24±2hrs after test conclusion
	whichever is larger	The charge/discharge current is less than 50mA.
	Q: 227 min.	
	IR : More than 1,000 № or 50 № × μF	
	Whichever is smaller	

	Performance	Test condition			
External Visual	No abnormal exterior appearance	Microscope ('10)			
Physical Dimensions	Within the specified dimensions	Using The calipers			
Mechanical Shock	Appearance : No abnormal exterior appearance Capacitance Change : Within ±2.5% or ±0.25pF whichever is larger Q, IR : Initial spec.	Three shocks in each direction should be applied along 3 mutually perpendicular axes of the test specimen (18 shocks) Peak value Duration Wave Velocity 1,500G 0.5ms Half sine 4.7m/sec			
Vibration	Appearance : No abnormal exterior appearance Capacitance Change : Within ±2.5% or ±0.25pF whichever is larger Q, IR : Initial spec.	5g's for 20min., 12cycles each of 3 orientations, Use 8"×5" PCB 0.031" Thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10~2,000Hz.			
Resistance to Solder Heat	Appearance : No abnormal exterior appearance Capacitance Change : Within ±2.5% or ±0.25pF whichever is larger Q, IR : Initial spec.	Preheating : 150°C for 60~120 sec. Solder pot : 260±5°C, 10±1sec.			
ESD	Appearance: No abnormal exterior appearance Capacitance Change: Within ±2.5% or ±0.25pF whichever is larger Q, IR: Initial spec.	AEC-Q200-002 or ISO/DIS10605			
Solderability	95% of the terminations is to be soldered evenly and continuously	a) Preheat at 155°C for 4 hours, Immerse in solder for 5s at 245±5°C b) Steam aging for 8 hours, Immerse in solder for 5s at 245±5°C c) Steam aging for 8 hours, Immerse in solder for 120s at 260±5°C solder: a solution ethanol and rosin			
Electrical Characterization	Capacitance: Within specified tolerance Q: 454 min. IR(25℃): More than 100,000 № or 1,000 №×μF Whichever is smaller. IR(125℃): More than 10,000 № or 100 №×μF Whichever is smaller.	The Capacitance / D.F. should be measured at 25 °C, 1 № ± 10%, 0.5~5 Vrms I.R. should be measured with a DC voltage not exceeding Rated Voltage @25 °C, @125 °C for 60~120 sec.			
Board Flex	Dielectric Strength Appearance : No abnormal exterior appearance Capacitance Change : Within ±5% or ±0.5pF whichever is larger	Dielectric Strength : 300% of the rated voltage for 1~5 seconds Bending to the limit, 3 mm for 60 seconds			
Terminal Strength(SMD)	Appearance : No abnormal exterior appearance Capacitance Change : Within ±2.5% or ±0.25pF whichever is larger	2 N, for 60 sec.			
Beam Load Temperature Characteristics	Destruction value should be exceed 8 N COG From -55 °C to 125 °C, Capacitance change should	Beam speed : 0.5±0.05 mm/sec be within 0±30ppm/℃			

D. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260 +0/-5 $^{\circ}$ C, 30sec.), Meet IPC/JEDEC J-STD-020 D Standard



A Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

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We will **NOT** be liable for any damages resulting from any misuse of the products, specifically including using the products for high reliability applications as listed below.

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- ① Aerospace/Aviation equipment
- ② Medical equipment
- 3 Military equipment
- 4 Disaster prevention/crime prevention equipment
- ⑤ Power plant control equipment
- 6 Atomic energy-related equipment
- ① Undersea equipment
- 8 Traffic signal equipment
- Data-processing equipment
- @ Electric heating apparatus, burning equipment
- Safety equipment
- @ Any other applications with the same as or similar complexity or reliability to the applications